

| L Number | Hits | Search Text | DB | Time stamp |
|----------|--------|---|-------|------------------|
| 1 | 1 | ("5690763").PN. | USPAT | 2004/06/12 14:06 |
| 2 | 1 | ("4467394").PN. | USPAT | 2004/06/12 14:14 |
| 3 | 1 | ("5644395").PN. | USPAT | 2004/06/12 14:15 |
| 4 | 97015 | doped | USPAT | 2004/06/12 14:15 |
| 5 | 67191 | intrinsic | USPAT | 2004/06/12 14:15 |
| 6 | 333042 | silicon | USPAT | 2004/06/12 14:15 |
| 7 | 10832 | doped adj silicon | USPAT | 2004/06/12 14:15 |
| 8 | 741 | intrinsic adj silicon | USPAT | 2004/06/12 14:15 |
| 9 | 231 | (doped adj silicon) and (intrinsic adj silicon) | USPAT | 2004/06/12 14:15 |
| 10 | 117928 | wafer wafers | USPAT | 2004/06/12 14:15 |
| 11 | 116 | ((doped adj silicon) and (intrinsic adj silicon)) and (wafer wafers) | USPAT | 2004/06/12 14:15 |
| 12 | 1069 | doped with intrinsic with silicon | USPAT | 2004/06/12 14:15 |
| 13 | 29 | (doped with intrinsic with silicon) with (wafer wafers) | USPAT | 2004/06/12 14:16 |
| 14 | 545321 | glass | USPAT | 2004/06/12 14:16 |
| 16 | 287903 | channels | USPAT | 2004/06/12 14:17 |
| 17 | 1 | ((doped with intrinsic with silicon) with (wafer wafers)) and glass) and channels | USPAT | 2004/06/12 14:17 |
| 15 | 10 | ((doped with intrinsic with silicon) with (wafer wafers)) and glass | USPAT | 2004/06/12 14:21 |
| 18 | 0 | ((("5690763").PN.) and (("4467394").PN.) and (("5644395").PN.) | USPAT | 2004/06/12 14:21 |
| 20 | 302219 | semiconductor | USPAT | 2004/06/12 14:21 |
| 21 | 2 | ((("5690763").PN.) (("4467394").PN.) ("5644395").PN.)) and semiconductor | USPAT | 2004/06/12 14:28 |
| 22 | 547424 | pyrex glass | USPAT | 2004/06/12 14:28 |
| 23 | 533 | field adj assisted | USPAT | 2004/06/12 14:29 |
| 24 | 44 | silicon with (pyrex glass) with (field adj assisted) | USPAT | 2004/06/12 14:29 |
| 25 | 3975 | oxygen adj ions | USPAT | 2004/06/12 14:29 |
| 26 | 0 | (silicon with (pyrex glass) with (field adj assisted)) and (oxygen adj ions) | USPAT | 2004/06/12 14:29 |
| 27 | 33 | (wafer wafers) and (silicon with (pyrex glass) with (field adj assisted)) | USPAT | 2004/06/12 14:43 |
| 19 | 3 | ((("5690763").PN.) (("4467394").PN.) ("5644395").PN.) | USPAT | 2004/06/12 14:33 |
| 29 | 0 | (field adj assisted) with (oxygen adj ions) | USPAT | 2004/06/12 14:43 |
| 30 | 178445 | ions | USPAT | 2004/06/12 14:43 |
| 31 | 28 | (field adj assisted) with ions | USPAT | 2004/06/12 14:43 |
| - | 333042 | silicon | USPAT | 2004/06/12 13:26 |
| - | 545321 | glass | USPAT | 2004/06/11 18:12 |
| - | 106278 | wafer | USPAT | 2004/06/11 18:12 |
| - | 30371 | silicon near wafer | USPAT | 2004/06/11 18:13 |
| - | 996650 | deposit deposited layer layered | USPAT | 2004/06/11 18:13 |
| - | 668 | glass with (silicon near wafer) with (deposit deposited layer layered) | USPAT | 2004/06/11 18:20 |
| - | 675571 | reactor reaction | USPAT | 2004/06/11 18:14 |
| - | 247 | (glass with (silicon near wafer) with (deposit deposited layer layered)) and (reactor reaction) | USPAT | 2004/06/11 18:20 |
| - | 287903 | channels | USPAT | 2004/06/11 18:14 |
| - | 24 | ((glass with (silicon near wafer) with (deposit deposited layer layered)) and (reactor reaction)) and channels | USPAT | 2004/06/11 18:20 |
| - | 21 | ("4708600" "4822250" "4908112" "5085562" "5171132" "5224843" "5252294" "5451788" "5519635" "5525041" "5611676" "5637469" "5677195" "5705018" "5816780" "5840062" "5856174" "5863502" "5876187" "5922591" "6054277").PN. | USPAT | 2004/06/11 18:18 |
| - | 9522 | pyrex | USPAT | 2004/06/11 18:20 |
| - | 30 | pyrex with (silicon near wafer) with (deposit deposited layer layered) | USPAT | 2004/06/11 18:20 |
| - | 7 | (pyrex with (silicon near wafer) with (deposit deposited layer layered)) and (reactor reaction) | USPAT | 2004/06/11 18:20 |

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|---|--------|--|-------|------------------|
| - | 6 | ((pyrex with (silicon near wafer) with (deposit deposited layer layered)) and (reactor reaction)) and channels | USPAT | 2004/06/11 18:21 |
| - | 94 | ashmead.in. | USPAT | 2004/06/11 18:21 |
| - | 930744 | plate | USPAT | 2004/06/11 18:21 |
| - | 931923 | ashmead.in. adn plate | USPAT | 2004/06/11 18:21 |
| - | 8 | ashmead.in. and plate | USPAT | 2004/06/11 18:22 |
| - | 2 | "field assisted bond" | USPAT | 2004/06/11 18:28 |
| - | 97015 | doped | USPAT | 2004/06/11 18:31 |
| - | 67191 | intrinsic | USPAT | 2004/06/11 18:31 |
| - | 237639 | dioxide | USPAT | 2004/06/11 18:31 |
| - | 476479 | aluminum | USPAT | 2004/06/11 18:31 |
| - | 117654 | gold | USPAT | 2004/06/11 18:31 |
| - | 709708 | electric | USPAT | 2004/06/11 18:31 |
| - | 3 | (US-6458325-\$ or US-5644395-\$ or US-4467394-\$).did. | USPAT | 2004/06/11 18:32 |
| - | 0 | doped and ((US-6458325-\$ or US-5644395-\$ or US-4467394-\$).did.) | USPAT | 2004/06/11 18:32 |
| - | 0 | intrinsic and ((US-6458325-\$ or US-5644395-\$ or US-4467394-\$).did.) | USPAT | 2004/06/11 18:32 |
| - | 0 | dioxide and ((US-6458325-\$ or US-5644395-\$ or US-4467394-\$).did.) | USPAT | 2004/06/11 18:32 |
| - | 0 | electric and ((US-6458325-\$ or US-5644395-\$ or US-4467394-\$).did.) | USPAT | 2004/06/11 18:32 |
| - | 1 | aluminum and ((US-6458325-\$ or US-5644395-\$ or US-4467394-\$).did.) | USPAT | 2004/06/11 18:33 |
| - | 1 | gold and ((US-6458325-\$ or US-5644395-\$ or US-4467394-\$).did.) | USPAT | 2004/06/11 18:36 |
| - | 10832 | doped adj silicon | USPAT | 2004/06/11 18:36 |
| - | 741 | intrinsic adj silicon | USPAT | 2004/06/11 18:36 |
| - | 1052 | wafer with (doped adj silicon) | USPAT | 2004/06/11 18:36 |
| - | 65 | wafer with (intrinsic adj silicon) | USPAT | 2004/06/11 18:36 |
| - | 3 | (wafer with (doped adj silicon)) and (wafer with (intrinsic adj silicon)) | USPAT | 2004/06/11 18:37 |
| - | 62822 | silicon adj dioxide | USPAT | 2004/06/11 18:37 |
| - | 4950 | wafer with (silicon adj dioxide) | USPAT | 2004/06/11 18:37 |
| - | 458512 | coated | USPAT | 2004/06/11 18:37 |
| - | 412 | (wafer with (silicon adj dioxide)) with coated | USPAT | 2004/06/11 18:38 |
| - | 225 | glass and ((wafer with (silicon adj dioxide)) with coated) | USPAT | 2004/06/11 18:38 |